

Electronic Acknowledgement Receipt

EFS ID:	6469855
Application Number:	10537509
International Application Number:	
Confirmation Number:	4531
Title of Invention:	Method for cutting semiconductor substrate
First Named Inventor/Applicant Name:	Fumitsugu Fukuyo
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Filer Authorized By:	Joseph John Buczynski
Attorney Docket Number:	46884-5388 (211285)
Receipt Date:	17-NOV-2009
Filing Date:	30-NOV-2005
Time Stamp:	15:31:53
Application Type:	U.S. National Stage under 35 USC 371

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		46884_5388_ids.pdf	179546	yes	4
			B64cd680f6843885090811318540c357a0926		

Multipart Description/PDF files in .zip description					
Document Description			Start	End	
Transmittal Letter			1	3	
Information Disclosure Statement (IDS) Filed (5B/08)			4	4	
Warnings:					
Information:					
2	NPL Documents	46884_5388_EPOA.pdf	249102 0a0a06766f412be4196e3c7111a8796539a20ac	no	6
Warnings:					
Information:					
3	Foreign Reference	46884_5388_JP17790.pdf	802651 179d01e0db4646ccc32b06e7b70a11e9a3fe0ff	no	13
Warnings:					
Information:					
4	Foreign Reference	46884_5388_JP046177.pdf	851133 0e0b7b3f906c173ab191479db9e6509aca016c1	no	11
Warnings:					
Information:					
5	Foreign Reference	46884_5388_JP098684.pdf	291178 1ad7935d423546f95e1fba8f5aaf20cb4b0bb	no	6
Warnings:					
Information:					
6	Foreign Reference	46884_5388_JP338468.pdf	1389020 dc0e41daac3514018071cd74b99bc1398f7090	no	18
Warnings:					
Information:					
7	Foreign Reference	46884_5388_JP338636.pdf	1393411 919b48bdc1150c7191b3b35db9a375f90664b76d	no	20
Warnings:					
Information:					
8	NPL Documents	46884_5388_jpoa.pdf	120946 851a7a2a89f805bdc0d1186517ad797c2d9186e	no	2
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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

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